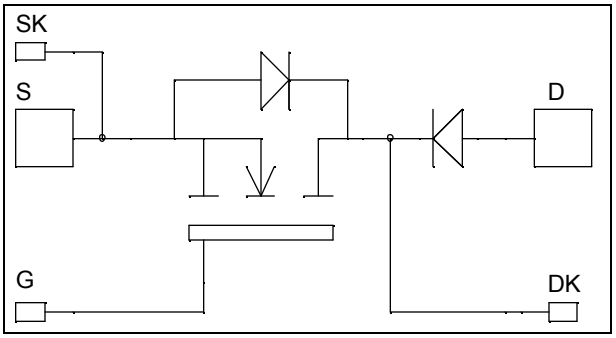
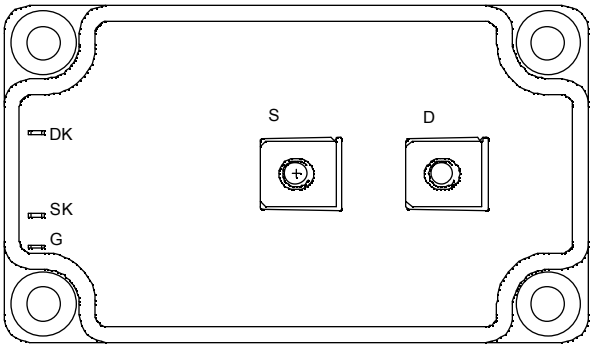
Single switch with Series diode MOSFET Power Module

V_{DSS} = 1000V
R_{DSon} = 45mΩ max @ Tj = 25°C
I_D = 215A @ Tc = 25°C





Application

- Zero Current Switching resonant mode

Features

- Power MOS 7® MOSFETs
  - Low R_{DSon}
  - Low input and Miller capacitance
  - Low gate charge
  - Avalanche energy rated
  - Very rugged
- Kelvin source for easy drive
- Very low stray inductance
  - Symmetrical design
  - M5 power connectors
- High level of integration
- AlN substrate for improved thermal performance

Benefits

- Outstanding performance at high frequency operation
- Direct mounting to heatsink (isolated package)
- Low junction to case thermal resistance
- Low profile

Absolute maximum ratings

Symbol	*Parameter*		*Max ratings*	*Unit*
V_{DSS}	Drain - Source Breakdown Voltage		1000	V
I_D	Continuous Drain Current	T_c = 25°C	215	A
		T_c = 80°C	160	
I_{DM}	Pulsed Drain current		860	
V_{GS}	Gate - Source Voltage		±30	V
R_{DSon}	Drain - Source ON Resistance		45	mΩ
P_D	Maximum Power Dissipation	T_c = 25°C	5000	W
I_{AR}	Avalanche current (repetitive and non repetitive)		30	A
E_{AR}	Repetitive Avalanche Energy		50	mJ
E_{AS}	Single Pulse Avalanche Energy		3200	

CAUTION: These Devices are sensitive to Electrostatic Discharge. Proper Handing Procedures Should Be Followed.

All ratings @ T_j = 25°C unless otherwise specified

Electrical Characteristics

Symbol	*Characteristic*	*Test Conditions*		*Min*	*Typ*	*Max*	*Unit*
BV_{DSS}	Drain - Source Breakdown Voltage	V_{GS} = 0V, I_D = 1.5mA		1000			V
I_{DSS}	Zero Gate Voltage Drain Current	V_{GS} = 0V, V_{DS}= 1000V	T_j = 25°C			600	µA
		V_{GS} = 0V, V_{DS}= 800V	T_j = 125°C			3	mA
$R_{DS(on)}$	Drain – Source on Resistance	V_{GS} = 10V, I_D = 107.5A				45	mΩ
$V_{GS(th)}$	Gate Threshold Voltage	V_{GS} = V_{DS}, I_D = 30mA		3		5	V
I_{GSS}	Gate – Source Leakage Current	V_{GS} = ±30 V, V_{DS} = 0V				±600	nA

Dynamic Characteristics

Symbol	*Characteristic*	*Test Conditions*	*Min*	*Typ*	*Max*	*Unit*
C_{iss}	Input Capacitance	V_{GS} = 0V V_{DS} = 25V f = 1MHz		42.7		nF
C_{oss}	Output Capacitance			7.6		
C_{rss}	Reverse Transfer Capacitance			1.3		
Q_g	Total gate Charge	V_{GS} = 10V V_{Bus} = 500V I_D = 215A		1602		nC
Q_{gs}	Gate – Source Charge			204		
Q_{gd}	Gate – Drain Charge			1038		
$T_{d(on)}$	Turn-on Delay Time	**Inductive switching @ 125°C** V_{GS} = 15V V_{Bus} = 670V I_D = 215A R_G = 0.5Ω		18		ns
T_r	Rise Time			14		
$T_{d(off)}$	Turn-off Delay Time			140		
T_f	Fall Time			55		
E_{on}	Turn-on Switching Energy ❶	**Inductive switching @ 25°C** V_{GS} = 15V, V_{Bus} = 670V I_D = 215A, R_G = 0.5Ω		7.2		mJ
E_{off}	Turn-off Switching Energy ❷			4.3		
E_{on}	Turn-on Switching Energy ❶	**Inductive switching @ 125°C** V_{GS} = 15V, V_{Bus} = 670V I_D = 215A, R_G = 0.5Ω		12		mJ
E_{off}	Turn-off Switching Energy ❷			5.8		

❶ E_{on} includes diode reverse recovery.
❷ In accordance with JEDEC standard JESD24-1.

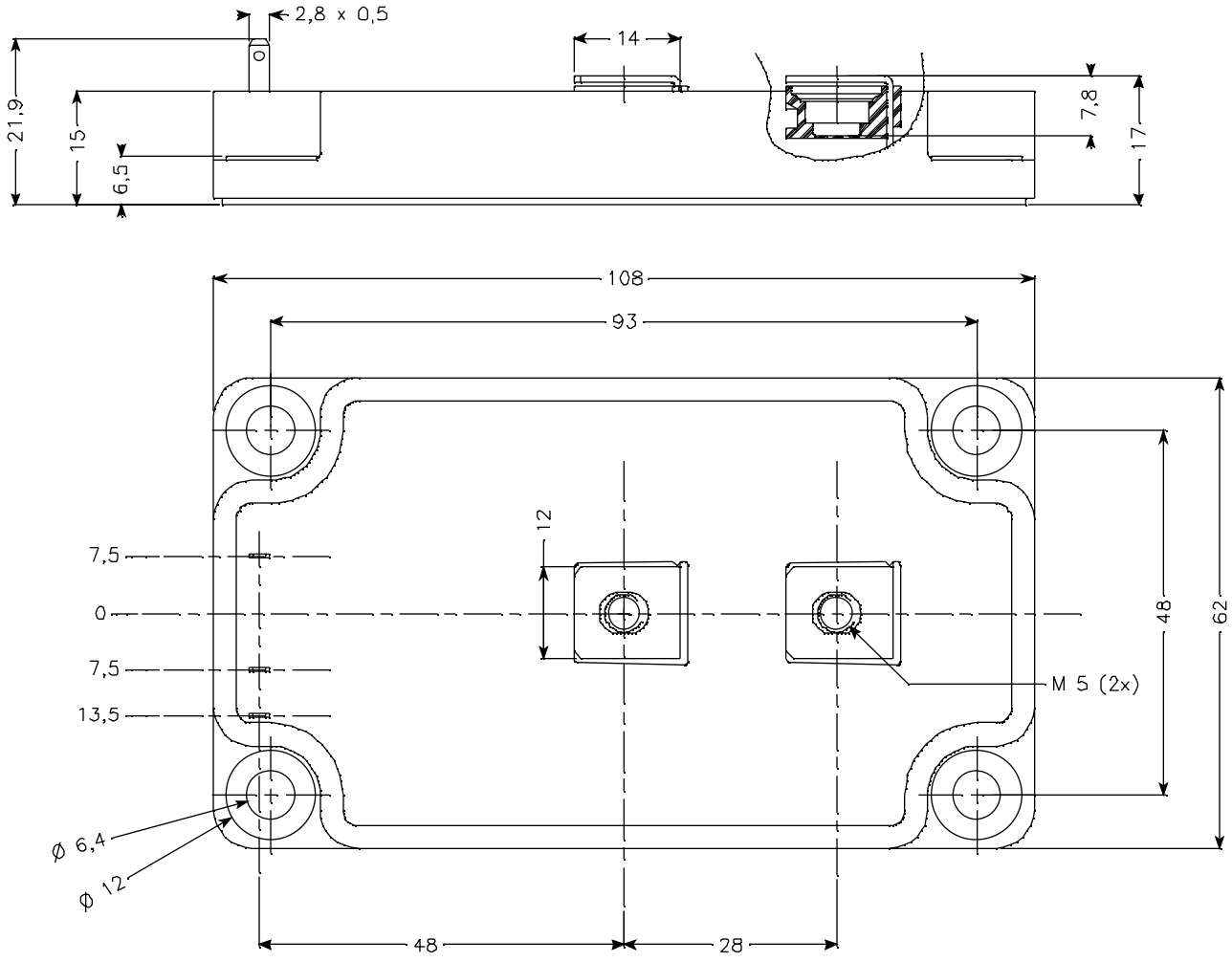
Series diode ratings and characteristics

Symbol	*Characteristic*	*Test Conditions*		*Min*	*Typ*	*Max*	*Unit*
V_{RRM}	Maximum Repetitive Reverse Voltage			1000			V
I_{RM}	Maximum Reverse Leakage Current	V_R=1000V	T_j = 125°C			3	mA
$I_{F(AV)}$	Maximum Average Forward Current	50% duty cycle	T_j = 90°C		360		A
V_F	Diode Forward Voltage	I_F = 360A			1.9	2.5	V
		I_F = 720A			2.2		
		I_F = 360A	T_j = 125°C		1.7		
t_{rr}	Reverse Recovery Time	I_F = 360A V_R = 667V di/dt = 800A/µs	T_j = 25°C		280		ns
			T_j = 125°C		350		
Q_{rr}	Reverse Recovery Charge	I_F = 360A V_R = 667V di/dt = 800A/µs	T_j = 25°C		4.56		µC
			T_j = 125°C		21.6		

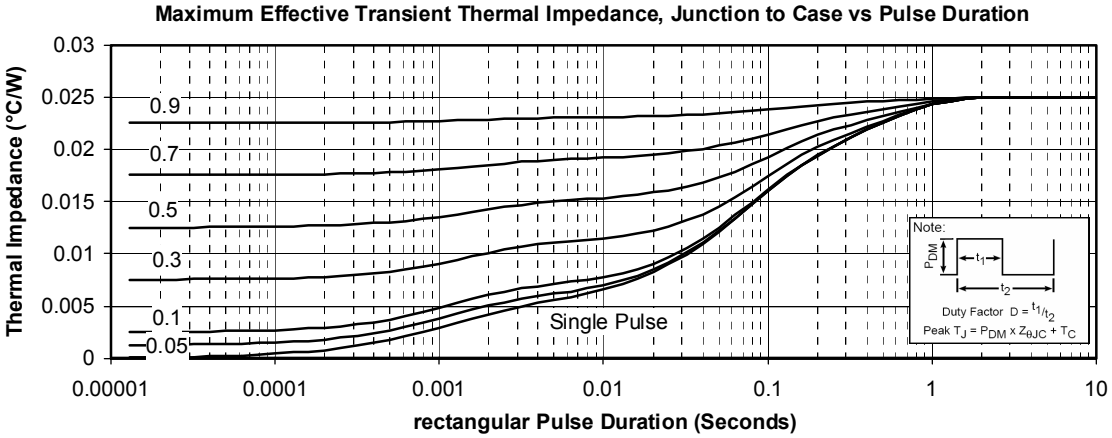
Thermal and package characteristics

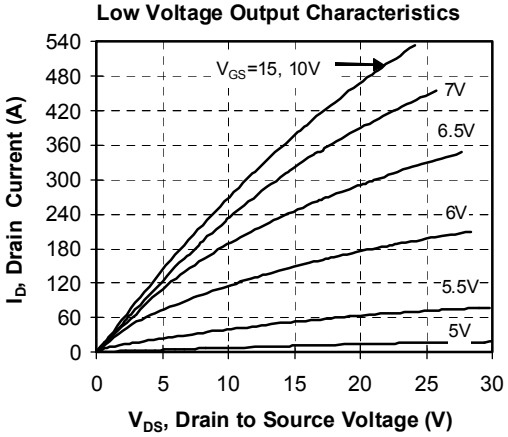
Symbol	*Characteristic*			*Min*	*Typ*	*Max*	*Unit*
R_{thJC}	Junction to Case		Transistor			0.025	°C/W
			Series diode			0.12	
V_{ISOL}	RMS Isolation Voltage, any terminal to case t =1 min, I isol<1mA, 50/60Hz			2500			V
T_J	Operating junction temperature range			-40		150	°C
T_{STG}	Storage Temperature Range			-40		125	
T_C	Operating Case Temperature			-40		100	
Torque	Mounting torque	To Heatsink	M6	3		5	N.m
		For teminals	M5	2		3.5	
Wt	Package Weight					280	g

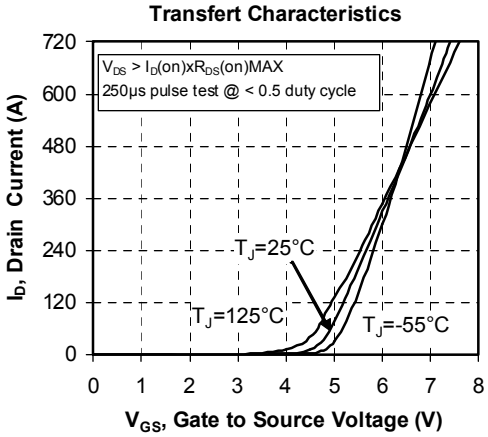
Package outline

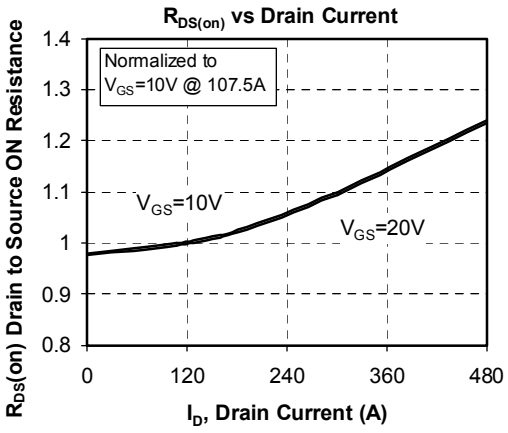


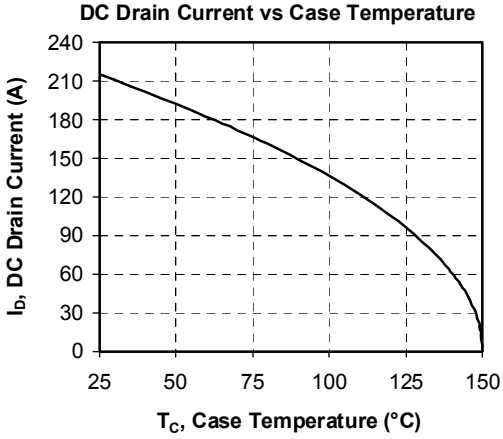
Typical Performance Curve



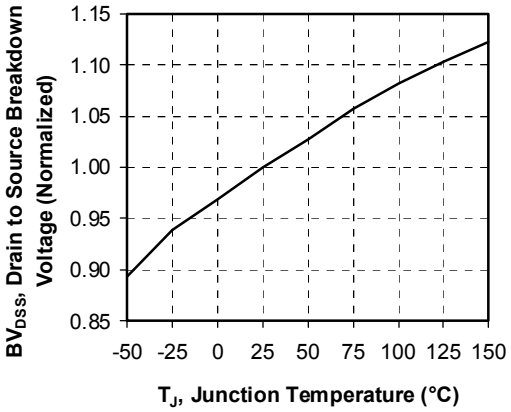




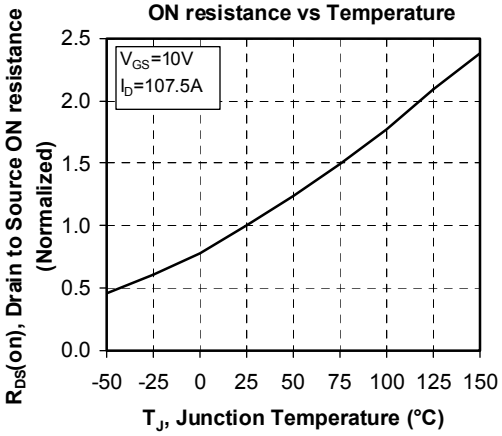




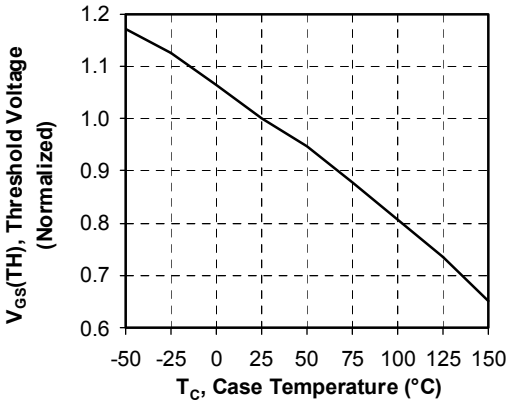
Breakdown Voltage vs Temperature



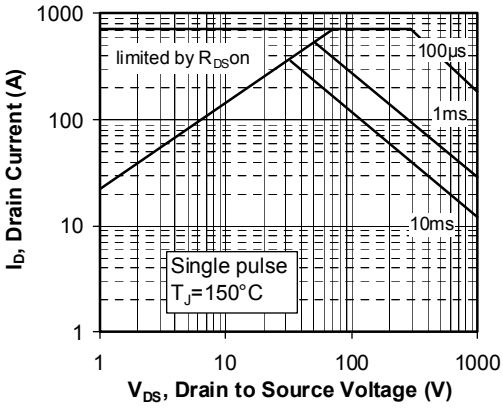
ON resistance vs Temperature



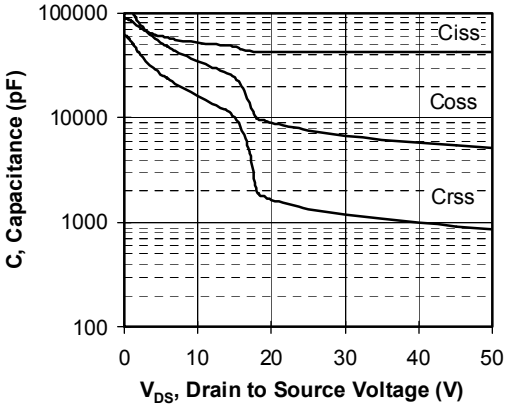
Threshold Voltage vs Temperature



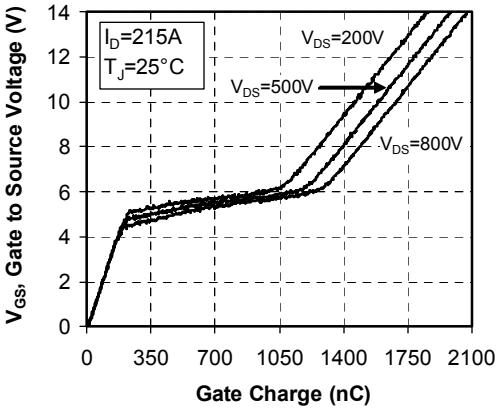
Maximum Safe Operating Area



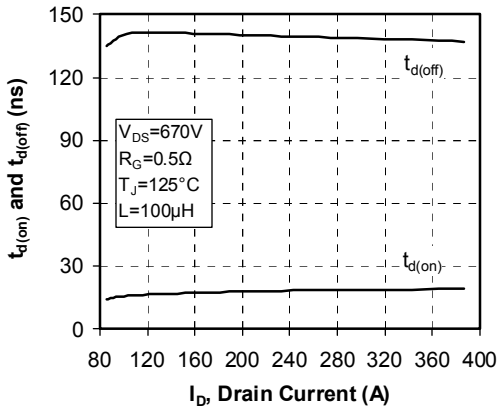
Capacitance vs Drain to Source Voltage



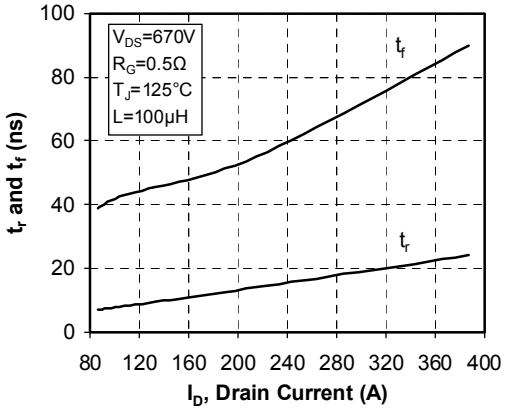
Gate Charge vs Gate to Source Voltage



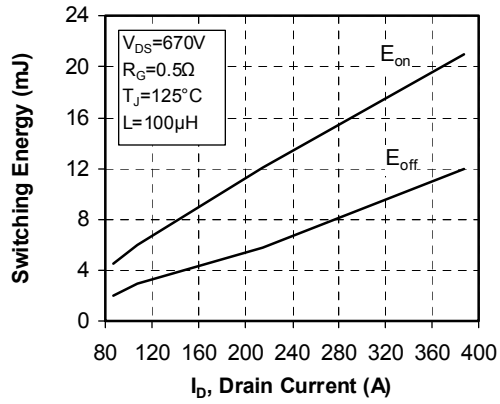
Delay Times vs Current



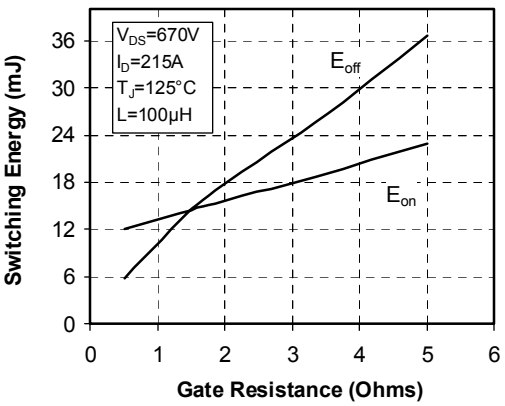
Rise and Fall times vs Current



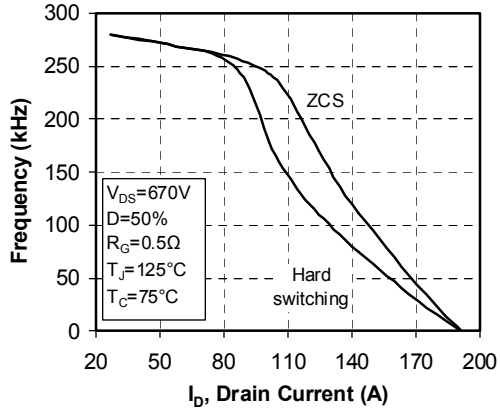
Switching Energy vs Current



Switching Energy vs Gate Resistance



Operating Frequency vs Drain Current



Source to Drain Diode Forward Voltage